

# Status of the BM@N detector upgrade

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### BM@N Experimental Setup



#### Forward Si tracking detectors performance at Ar and Kr beams (March 2018)



• Vertex plane-2 consists of 2 modules with sensitivity area  $12,5 \times 12,5$  cm<sup>2</sup>, 2560 strips

Si-3 detector residual vs GEM+Si track ~ 86 µm

#### Upgrade of the forward Si tracking detectors









Three sizes of Si-planes





Design of the Si-planes on the BM@N beam-channel

#### Plans:

06.2019 - ASIC VATAGP7.1 delivery

02.2020 – integration of the Si forward tracking detectors into BM@N setup

Station#	Number of	DSSD station	Number of
	DSSD modules	square	Readout
			channels
Station1	10	720 cm <sup>2</sup>	12800
Station2	14	1008 cm <sup>2</sup>	17920
Station3	18	1296 cm <sup>2</sup>	23040
Total	42	~0.3 m²	53760

Readout ASIC VATAGP7.1.

Number of sensitive pre-amplifier (CSA) inputs - 128 Input charges (dynamic range) -  $-30fC \div +30fC$ Peaking time (slow shaper) - 500ns (typ.) Good linearity for charges up to +/- 15fC Reading clock - 4,6MHz

### Tentative Design of the BM@N STS

Preliminary layout of BM@N STS was developed.

Geometry was tested in simulations in CbmRoot (E. Lavrik) and BmnRoot (S. Mertz)

Four stations are based on CBM-type modules with double-sided microstrip silicon sensors:

- Pitch 58µ
- Stereo angle 7.5°
- Thickness 300µ
- Sizes: 62x62, 62x42, 62x22 mm<sup>2</sup>
- Produced by two vendors: CiS (Germany) & Hamamatsu (Japan)



Plans:

2020 – first 42 modules integration into BM@N;

2022 – BM@N STS full configuration (292 modules)



Material Budget x/X [%], STS



Number of modules: 292 Number of channels: ~600k Power consumption: ~15 kW

#### Assembling of BM@N STS modules at JINR



Assembling of the mockups of BM@N STS modules

- Two clean rooms are already equipped for the module assembly
- Full set of jigs was developed, produced and tested on mockups
- QA procedure for all steps of assembling was developed
- Two technicians and two engineers are currently fully involved into assembling of BM@N modules
- First operable module was assembled and now is under tests

 FEB with
 Microcables +

 8x STSXYTER ASICs
 shielding

 sensor
 Image: Constraint of the sensor

First assembled module with 62x62 mm<sup>2</sup> sensor

#### GEM central tracking system performance at Ar and Kr beams (March 2018)



Example of the event reconstruction in the central tracker in Ar+Al interaction

Seven GEM 1632x450 mm<sup>2</sup> chambers produced at CERN workshop were integrated into BM@N experimental setup. One was defected, to be repaired at CERN (Spring 2019).

#### **GEM** tests at Ar beam



Pile-up suppression in Ar, Kr runs: 3 µs before and 0.5 µs after trigger signal



Magnetic field 0.6 T, Ar(90)/Isobutane(10), d beam, Edrift = 0.8kV/cm Magnetic field 0.6 T, Ar(80)/Isobutane(20), Ar beam, Edrift = 1.5kV/cm In Ar and Kr runs the value of electric field in drift gaps of GEM chambers was increased. The gas mixture was changed to Ar(80)/Isobutane(20). The Lorentz shift of electrons avalanche was decreased.

### **GEM occupancy**



Vertical sectors

Horizontal sectors

Two GEM 1632x450 mm<sup>2</sup> chambers with vertical sectors, five GEM 1632x450 mm<sup>2</sup> and seven GEM 1632x390 mm<sup>2</sup> chambers with horizontal sectors

#### First BM@N GEM 1632x390 mm<sup>2</sup> chamber was assembled at CERN (December 2018)



Schematic cross section of BM@N triple GEM detector





# Scheme of the GEM full planes configuration inside the magnet



First half of the 2019 – development of the mechanics for GEM planes precise installation inside the magnet. Lorentz shifts of an electron avalanche in GEM planes

![](_page_10_Figure_4.jpeg)

End of the 2019 – mechanics production, installation of the GEM planes.

#### Plans:

- 02.2019 – tests of the first 1632 mm  $\times$  390 mm chamber at JINR

- First half of the 2019 year - production of 6 GEM chambers of size 1632 mm  $\times$  390 mm to cover vertical acceptance of analyzing magnet

- End of the 2019 – integration of the full GEM planes into the experimental setup (electronics based on the VA-163 chips, ~90000 readout channels)

- Tests of the VMM3 and STSXYTER ASICs.

![](_page_11_Picture_5.jpeg)

# Forward Si, STS, GEM detectors installation scheme

![](_page_12_Picture_1.jpeg)

#### 2020 year

2022 year

### Schematic view of 1065x1065 mm<sup>2</sup> CSC

![](_page_13_Figure_1.jpeg)

![](_page_13_Figure_2.jpeg)

CSC is intended to precise parameters of tracks, obtained in GEM detectors inside the analyzing magnet. Beside improvement of particles momentum identification, refined track in CSC is used to find corresponding hit in time-of-flight system (ToF400).

Design and assembly – JINR LHEP

### Readout cathode planes

Each cathode plane consists of two printed circuit boards. Each pcb is divided on hot and cold zones.

![](_page_14_Figure_2.jpeg)

#### CSC chamber 1065x1065 mm<sup>2</sup>

![](_page_15_Picture_1.jpeg)

#### First beam test of CSC

C, Ar and Kr runs in March 2018: CSC chamber is installed in front of ToF-400 to check its performance as outer tracker for heavy ions

![](_page_16_Figure_2.jpeg)

## Schematic view of 2190x1453 mm<sup>2</sup> CSC

![](_page_17_Figure_1.jpeg)

Two cathode planes – 0° and 15° strips

Each cathode plane consists of 8 printed circuit boards.

Each pcb is divided on hot and cold zones.

![](_page_17_Figure_5.jpeg)

Cathode plane with 0° strips

Two 2190x1453 mm<sup>2</sup> CSC chambers are to be installed before and after ToF-700

Design and assembly – JINR LHEP

#### Plans:

- 04.2019: production of three  $1065 \times 1065 \text{ mm}^2$  chambers and design of the cathode planes for  $2190 \times 1453 \text{ mm}^2 \text{ CSC}$  chambers

-10.2019 – production of the cathode planes for 2190x1453 mm<sup>2</sup> CSC chambers

- 02.2020 – Assembly of the first  $2190x1453 \text{ mm}^2 \text{CSC}$ 

- 05.2020 - Assembly of the second 2190x1453 mm<sup>2</sup> CSC

- 12.2020 – All chambers are integrated into the BM@N experimental setup

![](_page_18_Picture_6.jpeg)

## Status ToF-400

![](_page_19_Figure_1.jpeg)

Preliminary result of identification, GEM+CSC track extrapolated to ToF-400

-1

0

2

з

dt, nsec

![](_page_19_Figure_3.jpeg)

Proton  $Mass^2 = 0,894 + -0,081 \text{ GeV}^2/c^4$ , Pion  $Mass^2 = 0,021 + -0,016 \text{ GeV}^2/c^4$ 

See talk of V.Plotnikov

### Status ToF-700

![](_page_20_Figure_1.jpeg)

## ECAL upgrade status

![](_page_21_Figure_1.jpeg)

cells.

#### **ZDC** Status

![](_page_22_Picture_1.jpeg)

To be replaced

#### **Plans:**

02.2019 – data analysis and ZDC calibration on cosmic muons will be performed by INR group

03.2019 – Tests of quartz hodoscope prototype at HADES and mCBM (GSI). Hodoscope will be installed after the calorimeter to precise the centrality measurements resolution and provide additional data on nucleus fragmentation

04.2019 - Transportation of CBM modules (20 pcs), FHCAL BM@N modules (16 pcs) and FHCal MPD modules (19 pcs) from INR at JINR.

05.2019 – Assembly of FHCAL at JINR

#### 35 FHCAL MPD modules (16\_BM@N+19\_MPD)

![](_page_22_Picture_9.jpeg)

#### 20 PSD CBM modules

54 modules:

Yellow – CBM modules – 20x20 cm, 10 sections – 20 modules - 10 T Blue – MPD modules – 15x15 cm, 7 sections - 34 modules - 6.8 T

![](_page_22_Figure_13.jpeg)

# Summary:

<b>Detector Subsystem</b>	Status	Upgrade Status
Forward Si detectors	3 small planes	3 full-size planes (02.2020)
STS BM@N		42 modules (2020) 292 modules (2022)
GEM	7 half planes (1 to be repaired)	7 full planes (2019)
CSC	l chamber 1065x1065 mm²	4 chambers 1065x1065 mm²(2019) 2 chambers 2190x1453 mm²(2020)
ECAL	one arm	two arms (2019)
ToF-400	full configuration	
ToF-700	full configuration	
ZDC		ZDC (MPD/CBM type) (2019)

# Back-up slides

## Readout electronics for BM@N STS

![](_page_25_Figure_1.jpeg)

**KIT Karlsruhe, Vladimir Sidorenko** 

![](_page_26_Figure_0.jpeg)

![](_page_26_Figure_1.jpeg)

#### Parameters

Transverse size, mm <sup>2</sup>	40x40
Module size, mm <sup>2</sup>	120x120
Number of layers	220
Lead absorber thickness, mm	0.3
Polystyrene scintillator thickness, mm	1.5
Moli'ère radius, mm	26
Radiation length, X <sub>0</sub>	11.8

**ADC64** is a 64-channel 12-bit 62.5 MS/s ADC device with signal processing core and Ethernet interface

![](_page_27_Picture_1.jpeg)

Cosmic test of the 9-cells module.

![](_page_27_Picture_3.jpeg)

9-channel power supply system

#### Detector council:

A.Maksymchuk	Technical coordinator, head of the detector council
S.Pijadin	BM@N chief engineer, infrastructure of the BM@N experimental zone
V.Slepnev	Coordination of BM@N and Nuclotron
V.Yurevich	Trigger and T0 detectors
N.Zamiatin	Forward silicon detectors, beam silicon detectors
D.Dementyev	STS detectors
S.Vasiliev	GEM detectors
A.Vishnevskiy	CSC detectors
M.Rumyancev	ToF-400
S.Afanasyev	ECAL
Yu.Petukhov	ToF-700
F.Guber	ZDC (MPD/CBM type)
S.Bazylev	DAQ
S.Habarov	Electronics for GEM, CSC, forward silicon detectors
V.Shutov	Slow control

Reconstruction of the primary vertex Si+GEM track (>=2 track), Ar-beam, Cu-target/1.67 mm (slide from G.Pokatashkin et al.)

![](_page_29_Picture_1.jpeg)

![](_page_29_Figure_2.jpeg)

Primary Vertex resolution of Z-coordinate  $G_z = 1.8$  mm at target thickness = 1.67 mm (without pile-up suppression)

#### Track residual of Si-2 (plane) vs Si+GEM track in magnetic field

![](_page_30_Picture_1.jpeg)

(slide from <u>G.Pokatashkin</u>, Yu.Gornaya, M.Kapishin, I.Rufanov, V.Vasendina, A.Zinchenko)

![](_page_30_Figure_3.jpeg)